

600V/800V Zero Cross 6-Pin Phototriac Optocoupler

Features

- High isolation 5000 VRMS
- Peak Breakdown Voltage
 - 600V CT3061,3062,3063
 - 800V CT3081,3082,3083
- Temperature range 55 °C to 100 °C
- Regulatory Approvals
 - UL UL1577 (E364000)
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - IEC60065, IEC60950

Applications

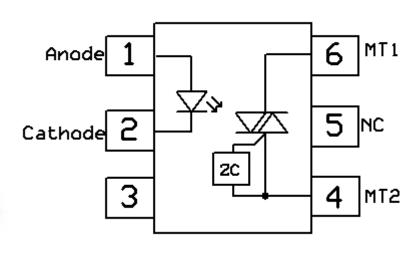
- Motor Controls
- Lamp ballasts
- Static AC Power Switch
- Solenoid/ Valve Control

Description

The CT3061, CT3062, CT3063, CT3081, CT3082 and CT3083 series consists of a Zero Cross Photo Triac optically coupled to a gallium arsenide Infrared-emitting diode in a 6-lead DIP package with different lead forming options.

Package Outline

Schematic



Note: Different lead forming options available. See package dimension.



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Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes	
Viso	Isolation voltage	5000	V _{RMS}		
Topr	Operating temperature		-55 ~ +100	°C	
Tstg	Storage temperature		-55 ~ +150	°C	
TsoL	Soldering temperature		260	°C	
Emitter		<u>'</u>			
l _F	Forward current	60	mA		
I _{F(TRANS)}	Peak transient current (≤1µs P.W,300pps)		1	А	
V_R	Reverse voltage		6	V	
PD	Power dissipation		100	mW	
Detector	-	·			
PD	Power dissipation		300	mW	
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	0,000	CT3061,3062,3063	600	V	
V_{DRM}	Off-State Output Terminal Voltage	CT3081,3082,3083	800	V	
I _{TM}	RMS on-state current		100	mA	
I _{TSM}	Peak Repetitive Surge Current		1	А	

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Electrical Characteristics $T_A = 25$ °C (unless otherwise specified)

Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	I _F =10mA	-	-	1.5	V	
I _R	Reverse Current	V _R = 6V	-	-	5	μΑ	
C _{IN}	Input Capacitance	f= 1MHz	-	45	-	pF	

Detector Characteristics

Symbol	Parameters		Test Conditions	Min	Тур	Max	Units	Notes
laa	Peak Blocking	CT3061,62,63	I _F = 0mA, V _{DRM} = Rated V _{DRM}			500	- Λ	
IDRM1	IDRM1 Current CT3081,82,83	IF= OTTA, VDRM= Kated VDRM	-	-	500	nA		
laa	Inhibit Leakage Current		I _F = Rated I _{FT} , V _{DRM} = Rated	-	ı	500		
I _{DRM2}			VDRM				μΑ	
V_{INH}	Inhibit Voltage		I _F = Rated I _{FT} ,	-	ı	20	٧	
V _{TM}	Peak On-State Voltage		I _F = Rated I _{FT} , I _{TM} = 100mA	-	-	3	V	
	Critical Rate of	CT3061,62,63		1000	-	-		
dv/dt	Rise off-State	CT3081,82,83	V _{PEAK} = Rated V _{DRM}	600			V/µs	
	Voltage			600		-		

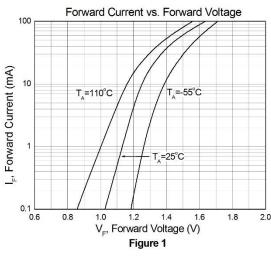
Transfer Characteristics

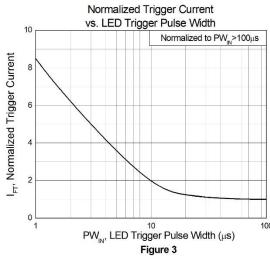
Symbol	Parameters		Test Conditions	Min	Тур	Max	Units	Notes
	Input	CT3061, CT3081	Torminal Valtage 2V	ı	-	15		
I _{FT}	Trigger	CT3062, CT3082	Terminal Voltage = 3V	-	-	10	mA	
	Current	CT3063, CT3083	I _{TM} =100mA	-	-	5		
I _H Holding Current		ırront	Terminal Voltage from "ON" to "OFF"	_	380	_	μΑ	
IH	Trolding Current		"ON" state I _F =0mA	-	300	-	μΛ	
Rıo	Isolation Resistance		V _{IO} = 500V _{DC}	1x10 ¹¹	-	-	Ω	
C _{IO}	Isolation Capacitance		f= 1MHz	-	0.25	-	pF	

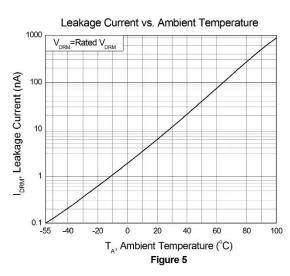


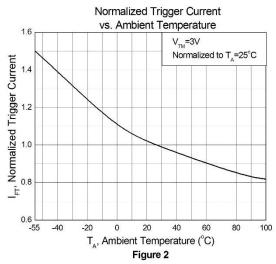
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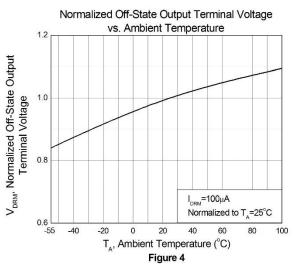
Typical Characteristic Curve

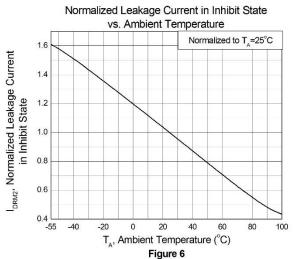






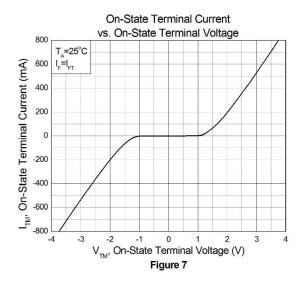


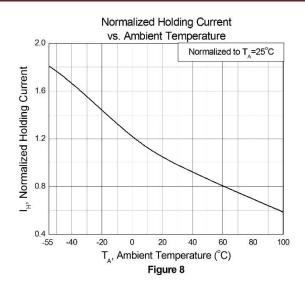


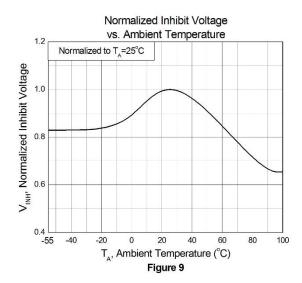




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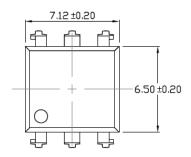


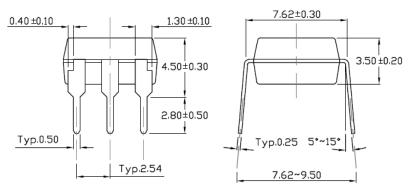


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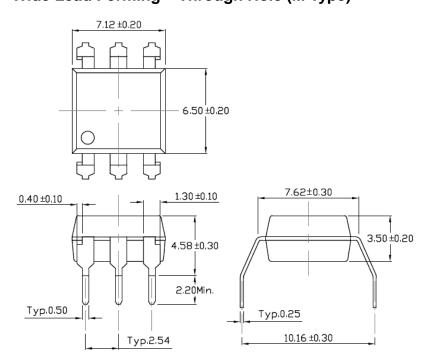
Package Dimension Dimensions in mm unless otherwise stated

Standard DIP - Through Hole





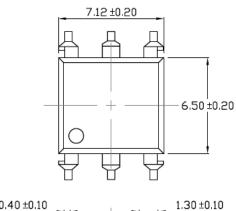
Wide Lead Forming – Through Hole (M Type)

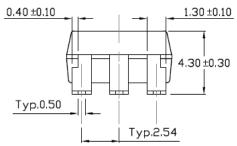


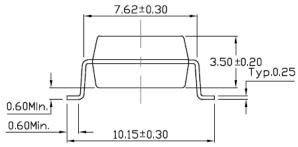


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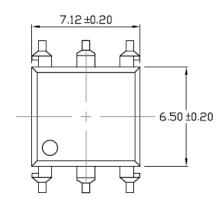
Surface Mount Forming (S Type)

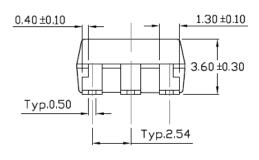


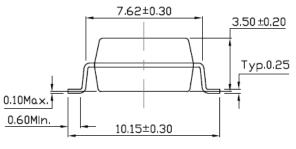




Surface Mount Forming (Low Profile) (SL Type)

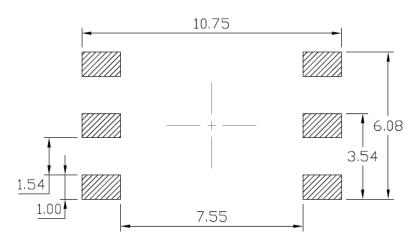




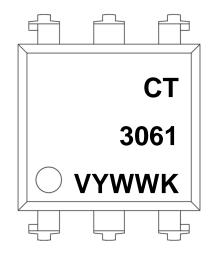


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Recommended Solder Mask Dimensions in mm unless otherwise stated



Marking Information



Note:

CT : Denotes "CT Micro"

3061 : Part NumberV : VDE OptionY : Fiscal YearWW : Work Week

K : Manufacturing Code

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Ordering Information

CT306X(V)(Y)(Z)-G, CT308X(V)(Y)(Z)-G

X = Part No.(X=1,2,3)

V = VDE Option (V or None)

Y = Lead form option (S, SL, M or none)

Z = Tape and reel option (T1, T2 or none)

G= Material option (G: Green, None: Non-green)

Option	Description	Quantity
None	Standard 6 Pin Dip	50Units/Tube
M	Gullwing (400mil) Lead Forming	50Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming– With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming – With Option 2 Taping	1000 Units/Reel



4.80

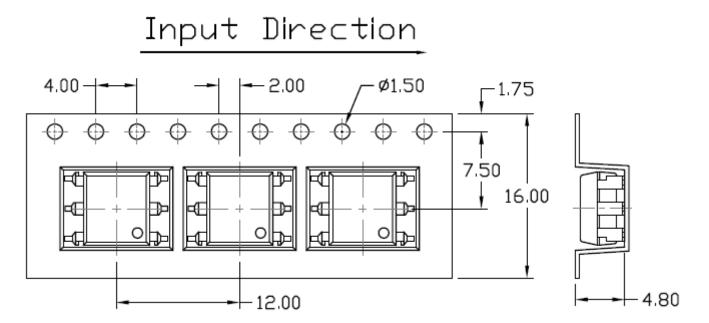
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Carrier Tape Specifications Dimensions in mm unless otherwise stated

Option S(T1) & SL(T1)

-12.00

Option S(T2) & SL(T2)



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Wave soldering (follow the JEDEC standard JESD22-A111)

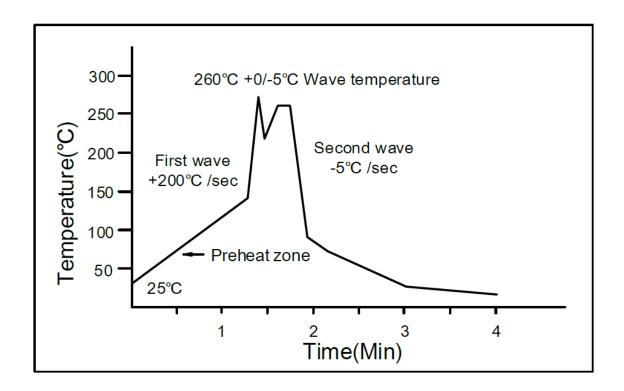
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C.

Time: 10 sec.

Preheat temperature:25 to 140°C.

Preheat time: 30 to 80 sec.



Hand soldering by soldering iron

Allow single lead soldering in every single process.

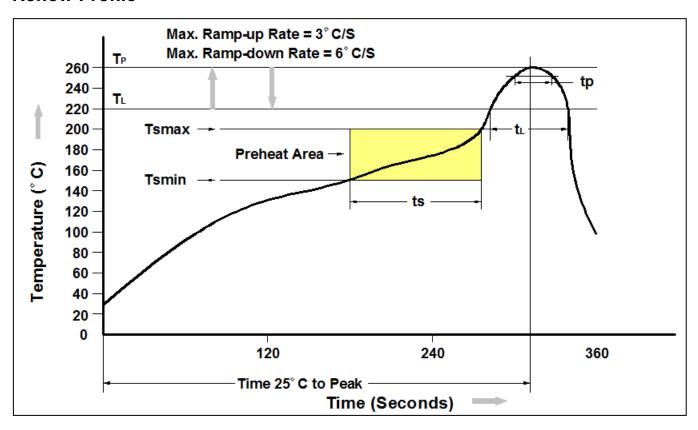
One time soldering is recommended. Temperature: 380+0/-5°C

Time: 3 sec max.



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Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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